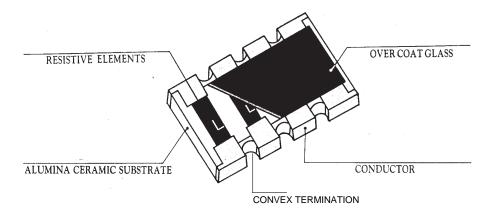
Cal-Chip Electronics, Incorporated

Thick Film Chip Resistor Arrays

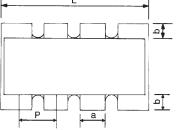
CONSTRUCTION

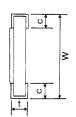
FEATURES

- High Density
- Automatic Placement
- Convex



DIMENSIONS IN MM





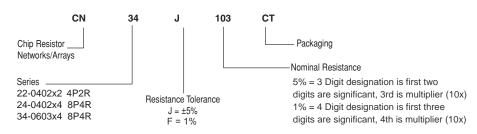
Jnit:	mm

TYPE	L	W	t	Р	а	b	С
CN34	3.2±0.1	1.6±0.15	0.55±0.1	0.8±0.5	0.45±0.1	0.3±0.2	0.3±0.2
CN24	2.0±0.1	1.0±0.1	0.4±0.1	0.5±0.05	0.3±0.1	0.15±0.1	0.25±0.2
CN22	1.0±0.1	1.0±0.1	0.35±0.1	0.65±0.05	0.3±0.1	0.15±0.1	0.25±0.2

RATING

ТҮРЕ	Power Rating at 70°C	Max Working Voltage	Max Overload Voltage	Operating Temp. (°C)	Resistance Tolerance	Resistance Range (Ω)	Temp Coefficient ppm/°C
CN34	1/16W	50V	100V	-55~+125°C	F±1% J±5%	0Ω~1ΜΩ	±200ppm/°C
CN24 CN22	1/16W	50V	100V	-55~+125°C	F±1% J±5%	0Ω~1ΜΩ	±250ppm/°C

Ordering Information



Note: Calchip has completed the Lead Free transition. All parts shipped with or without the "customer designator" LF at the end of the part number will be Lead-Free. Lead-Free material will still continue to have an LF at the end of the Lot Code and a green RoHS symbol on the label. Please contact your sales associate if you require non-RoHS material.

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1.0 Number of Element

Depend on its element's number. (2-2 element. 4-4 element)

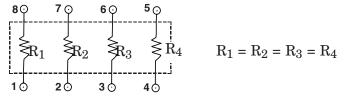
2.0 Resistance Tolerance

F: ±1% J: ±5%

3.0 Nominal Resistance

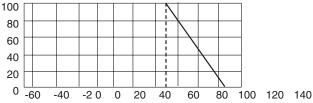
Example: 103, 10 is effective digit, 3 is a multiple which represents the cube of 10, zero number is three.

4.0 Schematics



5.0 Power Derating Curve

The resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve in Figure 1.



5.1 Rated Voltage

The value of rated voltage shall be determined from formula (1).

- $E = \sqrt{P \times R}$(1)
- E = Rated Voltage (V)
- P = Power Rating (W)
- $R = Nominal Resistance (\Omega)$

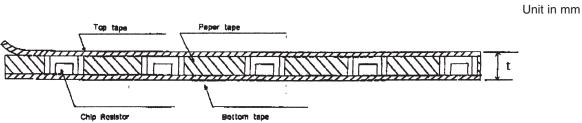
6.0 Electrical / Machine Characteristics and Test Methods

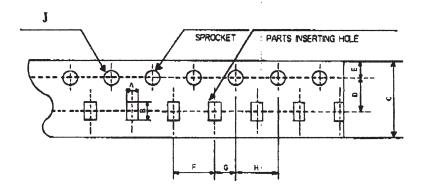
Item	Specifications	Test Methods	
Temperature Coefficient	TCR: ±200 ppm	Inspection Temp. Cold: +25°C~-55°C Hot: +25°C~+125°C	
Short Time Overload	±(2%+0.05Ω)	1. Apply 2.5 x rated voltage for 5 sec. 2. Wait 30 minutes 3. Measure resistance value	
Load Life	±(3%+0.05Ω)	 Dwell in chamber at 70±2°C for ON: 90 min. at rated voltage; then OFF: 30 min. Perform 1,000 hours cyclically 	
Load Life in Humidity	±(3%+0.05Ω)	 Dwell in humidity chamber at 40 ±2°C and 95% RH for ON: 90 min. at rated voltage; then OFF: 30 min. Perform 1.,000 hours cyclically 	
Temperature Cycling	±(1%+0.05Ω)	155±3°C~125±3°C, make 5 cycles. 2. Released 1 hour in room temp., then measure value.	
Effect of Soldering	t(2.5%+0.05Ω) 1. Immersed in molten solder at 270±5°C for Non-damage by machinery 2. Released 1 hour in room temp. then meas		
		 Immersed in rosin solution for 5~10 seconds. Re-immersed in solder pot at 230±5°C for 3±0.5 sec 	
Intermittent Overload	±(5%+0.1Ω)	 Perform 10,000 voltage cycles as follows: ON (2.5 x rated voltage or current) 1 sec. and OFF 25 sec. Released 30 min. without loading. Measure resistance. 	
Dielectric Withstanding Voltage	No evidence of mechanical damage	Apply 300VAC for 1 second	
Insulation Resistance	10 ⁸ Ω min	Apply 100VDC.	

Thick Film Chip Resistor Arrays

Taping Specification







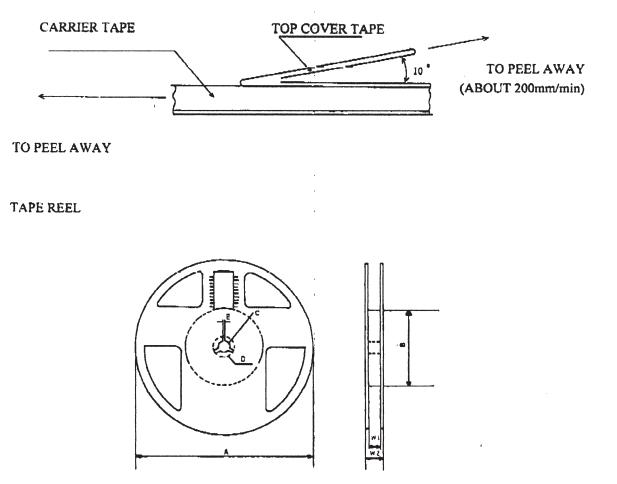
Paper Tape

Туре		Α	В	С	D	E	F	G	н	J	t
CN34	5,000	2.0±0.2	3.6±0.2	8.0±0.1	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5±0.1	1.0
CN24	10,000	2.0±0.15	2.4±0.2	8.0±0.2	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5±0.1/0	.84±.01

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The top fixed tape for each carrier shall have an adhesion peel strength of 10 to 50g, measure methods is shown below to peel away.



Туре	А	В	С	D	E	W1	W2
CN34	φ178±2.0	φ80±2.0	φ13±0.5	φ21.0	2.0±0.5	10.0±1.0	12.5±1.0
CN24	φ178±2.0	φ80±2.0	φ13±0.5	φ 21.0	2.0±0.5	10.0±1.0	12.5±1.0
CN22	φ178±2.0	φ80±2.0	φ13±0.5	φ21.0	2.0±0.5	9.0±1.0	11.4±2.0